PCN# 20240502009.1
Datasheet for INA117
Change Notification

Date: May 06, 2024
To: MOUSER PCN

Dear Customer:

This is a notice of change to a product data sheet for a device that is currently offered by Texas Instruments. The details of this change are on the following pages.

We request you acknowledge receipt of this notification within **30** days of the date of this notice. Lack of acknowledgement of this notice within 30 days constitutes acceptance and approval of this change. If samples or additional data are required, requests must be received within **30 days** of this notification.

The proposed first ship date is indicated on page 3 of this notification, unless customer agreement has been reached on an earlier implementation of the change.

This notice does not change the end-of-life status of any product. Should product affected be on a previously issued product withdrawal/discontinuance notice, this notification does not extend the life of that product or change the life time buy offering/discontinuance plan.

For questions regarding this notice, contact your local Field Sales Representative or the Change Management team.

Sincerely,

Change Management Team
SC Business Services

20240502009.1
Data Sheet Change Notification
Attachments

Products Affected:

The devices listed on this page are a subset of the complete list of affected devices. According to our records, you have recently purchased these devices. The corresponding customer part number is also listed, if available.

DEVICE	CUSTOMER PART NUMBER
INA117KU	NULL
INA117KU/2K5	NULL
INA117P	NULL

Technical details of this Product Change follow on the next page(s).

PCN Number:	20240502009.1		PCN Date:	May 06, 2024
Title:	Datasheet for INA117			
Customer Contact:	Change Management team	Dept:		Quality Services
Proposed 1st Ship Date:	August 04, 2024			
Change Type:				

	Assembly Site		Design		Wafer Bump Material
	Assembly Process	☒	Data Sheet		Wafer Bump Process
	Assembly Materials		Part number change		Wafer Fab Site
	Mechanical Specification		Test Site		Wafer Fab Materials
	Packing/Shipping/Labeling		Test Process		Wafer Fab Process

PCN Details

Description of Change:

The product datasheet(s) is being updated as summarized below.
The following change history provides further details.

TEXAS INSTRUMENTS

INA117
SBOS154B – SEPTEMBER 2000 – REVISED APRIL 2024

Changes from Revision A (November 2000) to Revision B (April 2024) Page

The datasheet number will be changing.

Device Family	Change From:	Change To:
INA117	SBOS154A	**SBOS154B**

These changes may be reviewed at the datasheet links provided.
http://www.ti.com/product/INA117

Reason for Change:			
To accurately reflect device characteristics.			
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):			
Electrical specification performance changes as indicated above.			
Changes to product identification resulting from this PCN:			
None.			
Product Affected:			
INA117KU	INA117KU/2K5	INA117KU/2K5G4	INA117P

For questions regarding this notice, e-mails can be sent to the Change Management team or your local Field Sales Representative.

IMPORTANT NOTICE AND DISCLAIMER